Primary-Side Regulation Dimmable LED Driver Controller with Active-PFC

General Description

The RT7331 is a dimmable constant current LED driver with active power factor correction. It supports high power factor across a wide range of line voltages, and it drives the converter in the Quasi-Resonant (QR) mode to achieve the higher efficiency. By using Primary Side Regulation (PSR), the RT7331 controls the output current accurately without a shunt regulator and an opto-coupler at the secondary side, reducing the external component count, the cost, and the volume of the driver board.

The RT7331 is compatible with the analog dimming. The output current can be modulated by the PWM duty ratio or the average level of DIM pin.

The RT7331 embeds comprehensive protection functions for robust designs, including LED open-circuit protection, LED short-circuit protection, output diode short-circuit protection, VDD Under-Voltage Lockout (UVLO), VDD Over-Voltage Protection (VDD OVP), over load protection, input under / over voltage protection, internal Over-Temperature Protection (OTP), and cycle-by-cycle current limitation.

Features

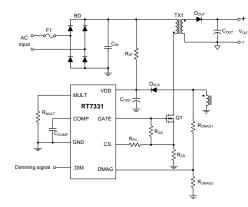
- Tight LED Current Regulation
- Smart CC/CV Mode Control
- Wide Dimming Range (1% to 100%)
- Power Factor Correction
- THD Optimization (THD < 10%)
- Quasi-Resonant (QR) Operation
- Fast Startup
- Adjustable CV level
- Soft Drive for the Better EMI Performance (Source 400mA/Sink 500mA)
- Multiple Protection Features
 - LED Open-Circuit Protection
 - LED Short-Circuit Protection
 - Over Load Protection
 - Input Under / Over Voltage Protection
 - Output Diode Short-Circuit Protection
 - VDD Under Voltage Lockout
 - VDD Over Voltage Protection
 - Internal OTP
 - ► Cycle-by-Cycle High / Low Line Current Limitation (1V/1.2V typ.)

Applications

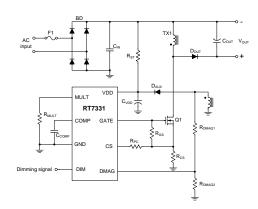
AC-DC LED Lighting Driver

Simplified Application Circuit

Flyback Application Circuit



Buck-Boost Application Circuit



¹





Ordering Information

RT7331 🗖 📮

Package Type S : SOP-8

-Lead Plating System G : Green (Halogen Free and Pb Free)

Note :

Richtek products are :

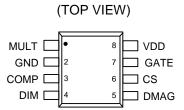
- ► RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ► Suitable for use in SnPb or Pb-free soldering processes.

Marking Information

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RT7331
GSYMDNN
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RT7331GS : Product Number YMDNN : Date Code

Pin Configuration

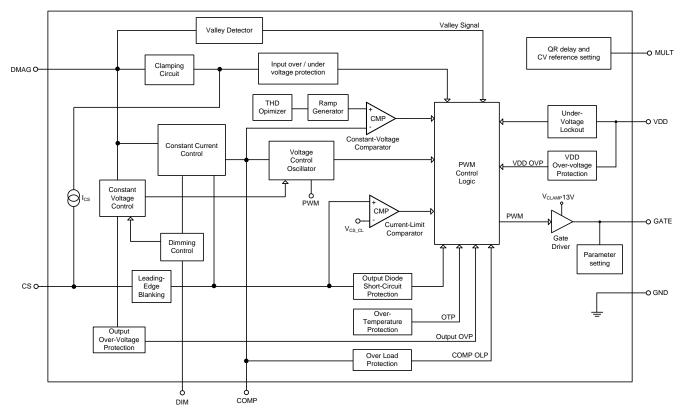


SOP-8

Functional Pin Description

Pin No.	Pin Name	Pin Function
1	MULT	Multi function. Set CV reference voltage and QR delay.
2	GND	Ground of the controller.
3	COMP	Compensation node. Output of the internal trans-conductance amplifier.
4	DIM	Dimming signal input. LED driving current can be modulated by the PWM duty ratio or the average level of this pin.
5	DMAG	Demagnetization pin. To detect the input and the output voltage from the auxiliary winding of the transformer.
6	CS	Current sense input. Connect this pin to the current sense resistor.
7	GATE	Gate driver output for an external power MOSFET. It is recommended to add an external totem pole circuit if the Qg of MOSFET is higher than 60nC.
8	VDD	Supply voltage (VDD) input. The controller will be enabled when VDD exceeds VTH_ON and disabled when VDD is lower than VTH_OFF.

Functional Block Diagram



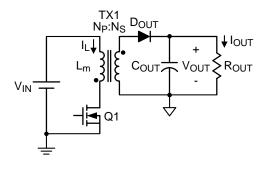
Operation

Critical-Conduction Mode (CRM) with Constant

On-Time Control

Figure 1 shows a typical flyback converter with the input voltage (V_{IN}). When the main switch Q1 is turned on with a fixed on-time (t_{ON}), the peak current (I_{L_PK}) of the magnetizing inductance (L_m) can be calculated by the following equation :

$$I_{L_PK} = \frac{V_{IN}}{L_m} \times t_{ON}$$



If the input voltage is the output voltage of the full-bridge rectifier (V_{IN_PK} x $|sin\theta|$), the inductor peak current (I_{L_PK}) can be expressed as the following equation :

$$I_{L_PK} = \frac{V_{IN_PK} \times |sin(\theta)| \times t_{ON}}{L_m}$$

As shown in Figure 2, when the converter operates in CRM with the constant on-time control, the envelope of the peak inductor current is in phase with the input voltage. Thus, the high power factor can be achieved.

Figure 1. Typical Flyback Converter



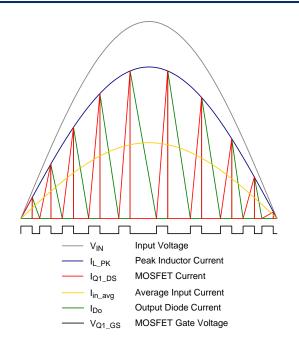


Figure 2. Inductor Current of CRM with Constant On-Time Control

The RT7331 needs no shunt regulator and opto-coupler at the secondary side to achieve the output current regulation. Figure 3 shows several key waveforms of a conventional flyback converter in Quasi-Resonant (QR) mode, in which V_{AUX} is the voltage on the auxiliary winding of the transformer.

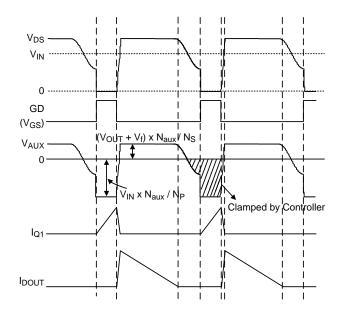


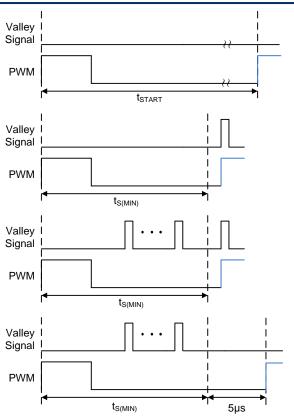
Figure 3. Key Waveforms of a Flyback Converter

Voltage Clamping Circuit

The RT7331 provides a voltage clamping circuit at DMAG pin since the voltage on the auxiliary winding is negative when the main switch is turned on. The lowest voltage on DMAG pin is clamped near zero to prevent the IC from being damaged by the negative voltage. Meanwhile, the sourcing DMAG current (IDMAG), flowing through the upper resistor (RDMAG1), is sampled and held to be a line-voltage-related signal for propagation delay compensation. The RT7331 embeds the programmable propagation delay compensation through CS pin. A sourcing current ICs (equal to IDMAG x KPC) applies a voltage offset (ICs x RPC) which is proportional to line voltage on CS to compensate the propagation delay effect. Thus, the output current can be equal at high and low line voltage.

Quasi-Resonant Operation

Figure 4 illustrates how valley signal triggers PWM. If no valley signal detected for a long time, the next PWM is triggered by a starter circuit at the end of the interval (tsTART, 127.5 μ s typ.). A blanking time (ts(MIN), 8.5 μ s typ.), which starts at the rising edge of the previous PWM signal, limits minimum switching period. When the ts(MIN) interval is on-going, all of valley signals are not allowed to trigger the next PWM signal. After the end of the ts(MIN) interval, the coming valley will trigger the next PWM signal. If one or more valley signals are detected during the ts(MIN) interval and no valley is detected after the end of the ts(MIN) interval, the next PWM signal will be triggered automatically at the end of the ts(MIN) + 5 μ s (typ.).

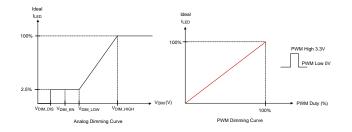




Dimming Function

The RT7331 features the analog and PWM dimming function.

When the average voltage on the DIM pin (VDIM) is within VDIM_LOW (0.36V typ.) and VDIM_HIGH, the regulation factor of the constant current control (Kcc) is linearly proportional to VDIM. The suggested PWM high level is 3.3V while the low level is 0V. The frequency of the PWM signal is recommended to be 1.2kHz. The analog and PWM dimming curves are shown in Figure 5. If there exists non-dimming requirement, a pull-high resistor of 1M Ω is needed to connect between DIM and VDD pins.





CV Mode

When VDIM is lower than VDIM_DIS for 15ms (typ.), the RT7331 will operate in CV mode. The output voltage is regulated by sensing the auxiliary winding voltage. Furthermore, the CV reference voltage can be selected by the MULT pin resistor RMULT.

Protections

The RT7331 embeds comprehensive protection functions, including LED open-circuit protection, LED short-circuit protection, output diode short-circuit protection, VDD Under-Voltage Lockout (UVLO), VDD Over-Voltage Protection (VDD OVP), over load protection, input under / over voltage protection, internal Over-Temperature Protection (OTP), and cycle-by-cycle current limitation.

VDD pin will sink an extra current (600µA typ.) when protections are triggered except for VDD UVLO and cycle-by-cycle current limitation.

LED Open-Circuit Protection

In an event of output open circuit, the converter will be shut down to prevent being damaged, and it will be auto-restarted when the output is recovered. Once the LED is open-circuit, the output voltage keeps rising, causing the voltage on DMAG pin VDMAG rising accordingly. When the sample-and-hold DMAG voltage exceeds its OV threshold (VDMAG_OVP, 3.8V typ.), output OVP will be activated and the GATE will be forced low to turn off the main switch. If the output is still open-circuit when the converter restarts, the converter will be shut down again.

LED Short-Circuit Protection

The RT7331 implements LED short-circuit protection by DMAG and CS pins. Once the DMAG voltage is lower than 0.5V (typ.) and the current sense voltage Vcs exceeds the peak current limitation (Vcs_cL) for few cycles, the converter will be shut down to prevent damage. It will be auto-restarted when the output is recovered.

The LED short-circuit protection is masked during the first 30ms (typ.) of power on (VDD > VTH_ON).

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Output Diode Short-Circuit Protection

When the output diode is damaged as short-circuit, the transformer will be led to magnetic saturation and the main switch will suffer from a high current stress. To avoid the above situation, an output diode short-circuit protection is built-in. When CS voltage Vcs exceeds the threshold (Vcs_sD 1.7 typ.) of the output diode short-circuit protection, the RT7331 will shut down the PWM output (GATE pin) in few cycles to prevent the converter from damage. It will be auto-restarted when the fault condition is recovered.

VDD Under-Voltage Lockout (UVLO) and Over-Voltage Protection (VDD OVP)

The RT7331 will be enabled when VDD voltage (VDD) exceeds rising UVLO threshold (VTH_ON, 20V typ.) and disabled when VDD is lower than falling UVLO threshold (VTH_OFF, 9V typ.).

When V_{DD} exceeds its over-voltage threshold (V_{DD_OVP} , 37V typ.), the PWM output of the RT7331 is shut down. It will be auto-restarted when the VDD is recovered to a normal level.

In order to ensure the VDD voltage can drop to UVLO threshold to reset some protection function, it is recommended to provide the power for the RT7331 VDD from the auxiliary winding of the transformer.

It should be noticed that the start up current IST must be less than the discharge current of capacitor CVDD, otherwise VDD may trigger VDD OVP in CV mode or low dim condition. In general, the RST is suggested to be greater than $650k\Omega$.

Input Over-Voltage and Under-Voltage Protection

When IDMAG is over the threshold current of VIN over-voltage protection (IDMAG_OCP) in few cycles, the GATE will shut down to avoid over stress on components. As soon as the input voltage drops below the brown-out threshold ($225\mu A$ typ.) for 70ms (typ.), the controller will shut down until it recovers to the brown-in threshold.

Over Load Protection

If the current sense resistor RCs is short-circuit, the COMP voltage will increase and result in over load operation. When VCOMP reaches to VCOMP_OLP (4.8V typ.) for 70ms (typ.), the main switch will be turned off.

Internal Over-Temperature Protection (OTP)

The RT7331 provides the internal OTP function to protect the controller itself from suffering the thermal stress and permanent damage. Once the junction temperature is higher than the OTP threshold (ToTP_STTH, 150°C typ.), the controller will shut down until the temperature decreases below 140°C (typ.).

RT7331

Absolute Maximum Ratings (Note 1)

Supply Voltage, VDD	0.3V to 40V
Gate Driver Output, GATE	–0.3V to 18V
Other Pins	–0.3V to 6.5V
 Power Dissipation, PD @ TA = 25°C 	
SOP-8	0.48W
Package Thermal Resistance (Note 2)	
SOP-8, θJA	206.9°C/W
Lead Temperature (Soldering, 10 sec.)	260°C
Junction Temperature	150°C
Storage Temperature Range	−65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV

Recommended Operating Conditions (Note 4)

Supply Input Voltage, VDD	11V to 34V
Junction Temperature Range	- –40°C to 125°C

Electrical Characteristics

(V_{DD} = 25V, T_A = 25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
VDD Section (VDD)						
VDD OVP Threshold Voltage	VDD_OVP			37		V
Rising UVLO Threshold Voltage	VTH_ON			20		V
Falling UVLO Threshold Voltage	VTH_OFF		8	9	10	V
VDD Holdup Mode Entry Point	Vdd_et			10.4		V
VDD Holdup Mode Ending Point	Vdd_ed			11		V
Start-up Current	IDD_ST	VDD = VTH_ON - 1V		12		μA
Operating Current	IDD_OP	V _{DD} = 15V, GATE and COMP pin open		650		μA
DMAG Section (DMAG)						
Lower Clamp Voltage	VDMAG_L	IDMAG = 1mA		105		mV
DMAG OVP Threshold Voltage	VDMAG_OVP			3.8		V
Threshold Current of Brown-in Protection	IDMAG_BRI			320		μA
Threshold Current of Vin Over Voltage Protection	IDMAG_OCP			1640	-	μA
High VIN Entry Level	IDMAG_HVSW			655		μA
DMAG Reference Voltage	VDMAG_REF	CV mode, R _{MULT} = $3.5k\Omega$		1.2		V
DMAG Threshold Voltage of Soft Start	VDMAG_SS	When V _{DMAG} < V _{DMAG_SS} , soft start		0.5		V

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Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
DMAG Threshold for Output UVP	Vth_uvp	VTH_UVP = VDMAG_SS		0.5		V
Minimum DMAG Masking Time	tbk(MIN)	Vcs = 0V		1		μS
Maximum DMAG Masking Time	tbk(max)	Vcs = 1.2V		3.4		μS
Constant Current Control Sect	ion (COMP)					
COMP Over Load Protection Threshold				4.8		V
Minimum COMP Voltage	VCOMP(MIN)			1.7		V
Maximum Regulated factor for constant-Current Control	KCC(MAX)	VDIM = 3V, VCOMP = 3V		250		mV
Current Sense Section (CS)						
Leading Edge Blanking Time	tLEB			400		ns
Low Vin Peak Current Limit at Normal Operation	VCL_LV	Idmag < 635μA		1.2		V
Peak Current Limit in VDD Holdup and CV Mode	VCL_MIN	CV mode or VDD < VDD_ET		0.2		V
Peak Current Shutdown Voltage Threshold	Vcs_sd			1.7		V
Propagation Delay Compensation Factor	Крс	ICS = KPC x IDMAG, IDMAG = -500μA		0.044		A/A
Gate Driving Section (GATE)						
Rising Time	tR	V _{DD} = 15V, C _L = 1nF (10% to 90%)		160		ns
Falling TimetFVDD = 15V, CL = 90%)		V _{DD} = 15V, C _L = 1nF (10% to 90%)		30		ns
Gate Output Clamping Voltage	VCLAMP	VDD = 15V		13		V
Internal Pull Low Resistor	Rgate	VDD < VTH_ON, before startup		60		kΩ
Timing Control Section						
Minimum Switching Period	ts(MIN)	VCOMP > 2.6V		8.5		μS
Minimum Switching Period in Green Mode	ts(MIN)_GM	VCOMP < 1.8V		500		μS
Start Time During Startup and Normal Operation	t START	VCOMP > 2.6V		127.5		μS
Max. Start time in Green Mode	tSTART_GM	VCOMP < 1.8V		7.5		ms
	ton(MIN)_LV	Idmag = -500μA		900		ns
Minimum On Time	ton(MIN)_HV	IDMAG = -900μA		700		ns
Maximum On Time	ton(max)			20		μS
Dimming Section						
Analog Dimming High Threshold Voltage	V _{DIM_HIGH}			2.8		V
Analog Dimming Enable Threshold Voltage	V _{DIM_EN}			300		mV
Analog Dimming Disable Threshold Voltage	V _{DIM_DIS}		246.3	250	253.7	mV

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Parameter	Symbol	Min	Тур	Max	Unit			
Parameter Setting Section (MULT)								
Detection Sourcing Current	ldet	During tdet		20		μA		

Note 1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 2. θ_{JA} is measured under natural convection (still air) at $T_A = 25^{\circ}C$ with the component mounted on a low effective-thermal-conductivity two-layer test board on a JEDEC thermal measurement standard.

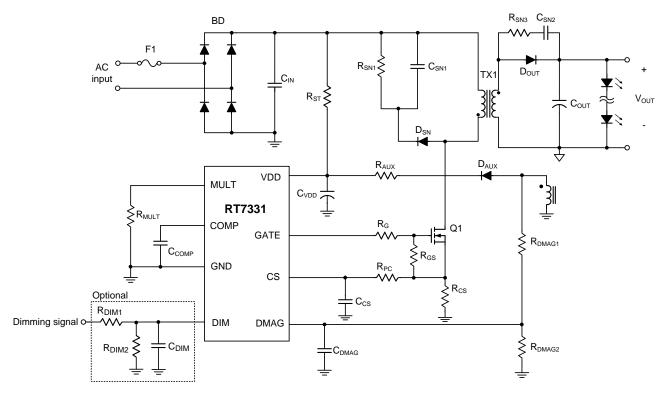
Note 3. Devices are ESD sensitive. Handling precaution is recommended.

Note 4. The device is not guaranteed to function outside its operating conditions.

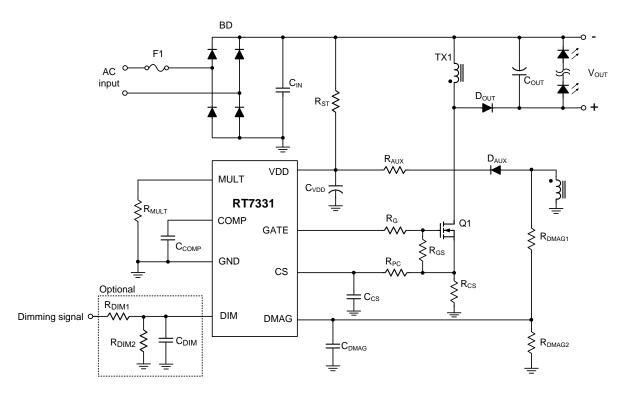
Note 5. Guarantee by design.

Typical Application Circuit

Flyback Application Circuit

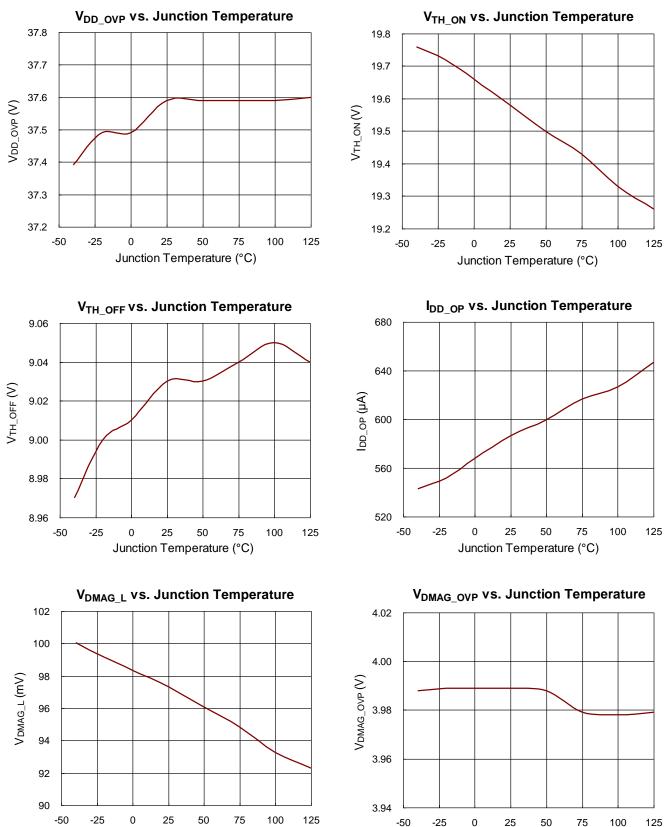


Buck-Boost Application Circuit



RT7331

Typical Operating Characteristics

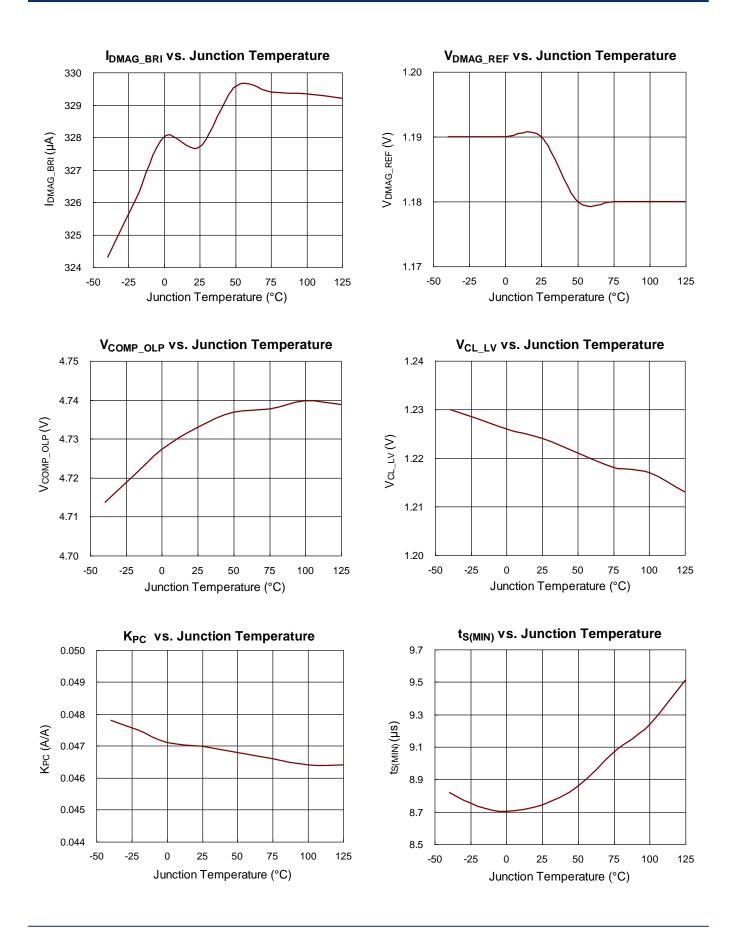


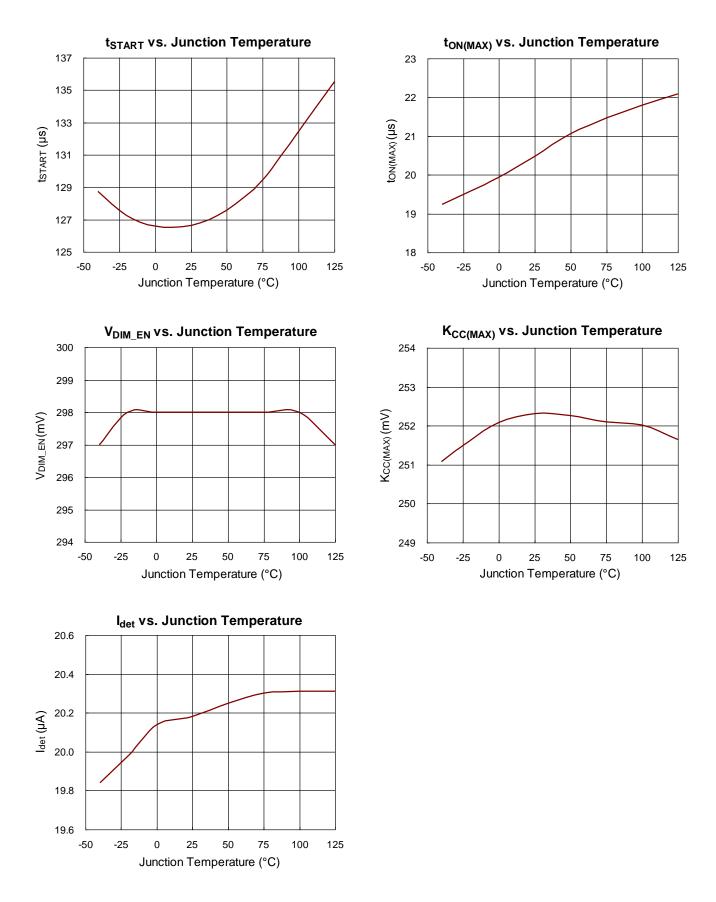
5 0 25 50 75 10 Junction Temperature (°C)

Junction Temperature (°C)

RT7331







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Application Information

Output Current Setting

Considering the conversion efficiency, the programmed DC level of the average output current (IOUT(t)) can be derived as :

$$I_{OUT_CC} = \frac{1}{2} \times \frac{N_{P}}{N_{S}} \times \frac{K_{CC}}{R_{CS}} \times CTR_{TX1}$$

 $CTR_{TX1} = \frac{I_{SEC_PK}}{I_{PRI_PK}} \times \frac{N_S}{N_P}$

in which CTRTX1 is the current transfer ratio of the transformer TX1, ISEC_PK is the peak current of the secondary side, and IPRI_PK is the peak current of the primary side. CTRTX1 can be estimated to be 0.9. According to the above parameters, current sense resistor Rcs can be determined as the following equation :

 $RCS = \frac{1}{2} \times \frac{NP}{NS} \times \frac{KCC}{I_{OUT_CC}} \times CTR_{TX1}$

Propagation Delay Compensation Design

The V_{CS} deviation (Δ V_{CS}) caused by propagation delay effect can be derived as:

$$\Delta V_{CS} = \frac{V_{IN} \cdot t_D \cdot R_{CS}}{L_m} ,$$

in which tD is the delay period which includes the propagation delay of the RT7331 and the turn-off transition of the main MOSFET. The sourcing current from CS pin of the RT7331 (Ics) can be expressed as :

$$I_{CS} = K_{PC} \cdot V_{IN} \cdot \frac{N_A}{N_P} \cdot \frac{1}{R_{DMAG1}}$$

where NA is the turns number of the auxiliary winding. RPC can be designed by :

$$R_{PC} = \frac{\Delta V_{CS}}{I_{CS}} = \frac{t_D \cdot R_{CS} \cdot R_{DMAG1}}{L_m \cdot K_{PC}} \cdot \frac{N_P}{N_A}$$

CV Reference and QR Delay Setting

After startup, the CV reference voltage and the QR delay is determined by the MULT pin resistor R_{MULT} . The corresponding values of the different R_{MULT} are as follows :

CV Voltage	QR delay = 100ns to 500ns
1.2V	$R_{MULT} = 3.5 k\Omega$ to $17.5 k\Omega$
1V	$R_{MULT} = 24.5 k\Omega$ to $122.5 k\Omega$
0.73V	$R_{MULT} = 171.5 k\Omega$ to $857.5 k\Omega$

Provided that the CV reference voltage is chosen as 1.2V (typ.) and the estimated half of the resonant period of the magnetizing inductance L_m and the parasitic capacitance of MOSFET is 100ns, R_{MULT} can be designed as the following equation :

$$R_{MULT} = 3.5k\Omega \times \frac{100ns}{100ns} = 3.5k\Omega \text{ (typ.)}$$

COMP Voltage Design

The COMP voltage, VCOMP, can be expressed as follows :

$$V_{\text{COMP}} = \frac{V_{\text{THDO}} \times G_{\text{m}_{ramp}} \times t_{\text{on}_{pk}}^2 \times f_{\text{s}_{pk}}}{C_{ramp}} + V_{\text{D}}$$

where ton_pk and fs_pk are the peak values at VIN_PK, Gm_ramp and Cramp are the fixed parameters in RT7331 and the typical values are : $Gm_ramp = 2.7 \mu A/V$, Cramp = 6.5 pF. V_D is the offset of the constant-voltage comparator and its typical value is 2V.

V_{THDO} is the input voltage of the THD optimizer and it can be selected as different voltages by the external Gate-to-Source resistor R_{GS}. The recommended R_{GS} is 22k Ω or 47k Ω , and the corresponding values of V_{THDO} are 1.2V (typ.) and 0.9V (typ.), respectively. It is recommended to design V_{COMP} = 3.5 to 4.2V. If V_{COMP} is over 4.2V, the output current regulation may be affected.

Input Under-Voltage Protection Setting

The input voltage is detected by RDMAG1, which is used to set the input UV level (VIN_UVP). Thus, RDMAG1 can be determined by the following equation :

$$R_{DMAG1} = V_{IN_pk} \times \frac{N_A}{N_P} \times \frac{1}{I_{DMAG_BRI}}$$

where IDMAG_BRI is the fixed parameters in RT7331 and its typical value is $320\mu A$.

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Output Over-Voltage Protection Setting

Output OVP is achieved by sensing the voltage on the auxiliary winding. It is recommended that output OV level (VOUT_OVP) is set at 120% of nominal output voltage (VOUT). Thus, RDMAG1 and RDMAG2 can be determined by the equation as :

 $V_{OUT} \times \frac{N_A}{N_S} \times \frac{R_{DMAG2}}{R_{DMAG1} + R_{DMAG2}} \times 120\% = 3.8V(typ.)$

Adaptive Blanking Time

When the MOSFET is turned off, the leakage inductance of the transformer and parasitic capacitance (Coss) of the MOSFET induce resonance waveform on the DMAG pin. The resonance waveform may make the controller false trigger the DMAG OVP, and it may cause the controller operate in unstable condition. As load increases, the resonance time also increases. It is recommended to add a 10pF to 47pF bypass capacitor, and it should be as close to DMAG pin as possible. The larger bypass capacitor may cause phase shift on DMAG waveform, so the MOSFET is not turned on at exact valley point.

To avoid the above issue, the RT7331 provides adaptive blanking time (t_{BK}). It varies with the peak voltage of the CS pin (V_{CS_PK}), as shown by the following formula :

 $tBK = 1\mu s + VCS_{PK} \times 2\mu s/V$ (typ.)

Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature T_J(MAX), listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula :

$\mathsf{PD}(\mathsf{MAX}) = (\mathsf{TJ}(\mathsf{MAX}) - \mathsf{TA}) / \theta \mathsf{JA}$

where $T_{J(MAX)}$ is the maximum junction temperature, TA is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance. For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance, θ_{JA} , is highly package dependent. For a SOP-8 package, the thermal resistance, θ_{JA} , is 206.9°C/W on a standard JEDEC low effective-thermal-conductivity two-layer test board. The maximum power dissipation at TA = 25°C can be calculated as below :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (206.9^{\circ}C/W) = 0.48W$ for a SOP-8 package.

The maximum power dissipation depends on the operating ambient temperature for the fixed $T_{J}(MAX)$ and the thermal resistance, θ_{JA} . The derating curves in Figure 6 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

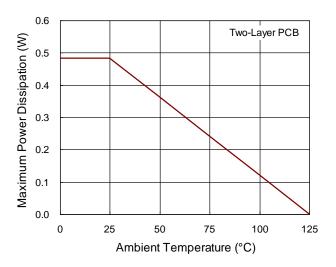


Figure 6. Derating Curve of Maximum Power Dissipation

RT7331

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Layout Considerations

A proper PCB layout can abate unknown noise interference and EMI issue in the switching power supply. Please refer to the guidelines when designing a PCB layout for switching power supply :

- The current path(1) from the input capacitor, transformer, MOSFET, Rcs returning to input capacitor is a high frequency current loop. The path(2) from GATE pin, MOSFET, Rcs returning to the ground of the IC is also a high frequency current loop. They must be as short as possible to decrease noise coupling and kept a space to other low voltage traces, such as IC control circuit paths, especially. Besides, the path(3) between MOSFET ground(b) and IC ground(d) is recommended to be as short as possible, too.
- The path(4) from RCD snubber circuit to MOSFET is a high switching loop. Keep it as small as possible.

- The path(5) from the input capacitor to VDD pin is a high voltage loop. Keep a space from path(5) to other low voltage traces.
- It is good for reducing noise, output ripple and EMI issue to separate ground traces of the input capacitor(a), MOSFET(b), auxiliary winding(c) and IC control circuit(d). Finally, connect them together at the input capacitor ground(a). The areas of these ground traces should be kept large.
- ► To reduce the parasitic trace inductance and EMI, the area of the loop connecting to the secondary winding, the output diode, and the output filter capacitor must be minimized. In addition, the sufficient copper area at the anode and cathode terminal of the output diode can help for heat-sinking. It is recommended to apply the larger area at the quiescent cathode terminal. The large anode area will induce high-frequency radiated EMI.

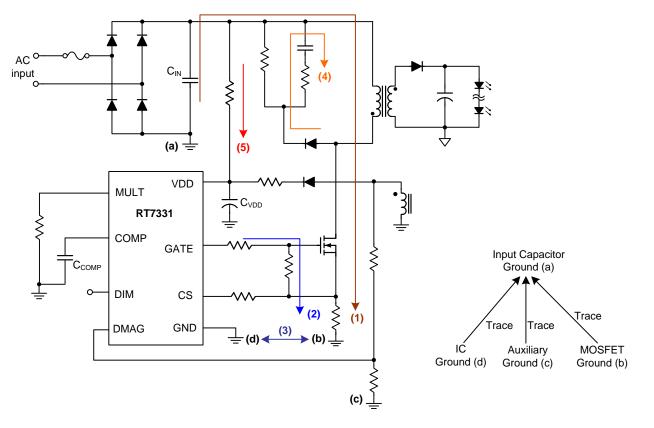
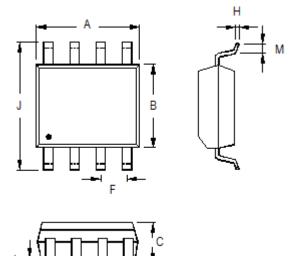


Figure 7. PCB Layout Guide



Outline Dimension

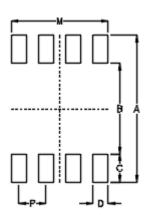


Completed	Dimensions I	n Millimeters	Dimension	s In Inches	
Symbol	Min	Мах	Min	Мах	
А	4.801	5.004	0.189	0.197	
В	3.810	3.988	0.150	0.157	
С	1.346	1.753	0.053	0.069	
D	0.330	0.508	0.013	0.020	
F	1.194	1.346	0.047	0.053	
Н	0.170	0.254	0.007	0.010	
Ι	0.050	0.254	0.002	0.010	
J	5.791	6.200	0.228	0.244	
М	0.400	1.270	0.016	0.050	

8-Lead SOP Plastic Package



Footprint Information



Dealer	Dookogo	Number of Pin	Footprint Dimension (mm)					Toloropoo	
	Package		Р	А	В	С	D	М	Tolerance
	SOP-8	8	1.27	6.80	4.20	1.30	0.70	4.51	±0.10

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